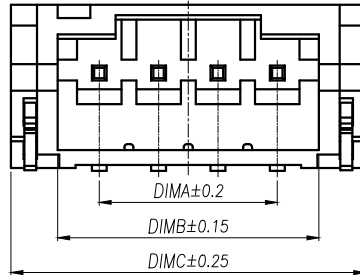
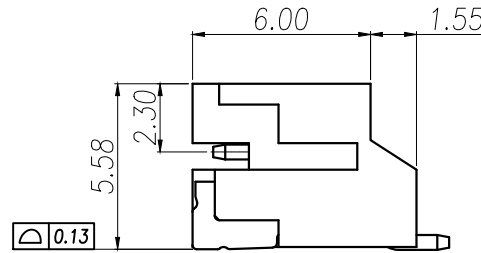
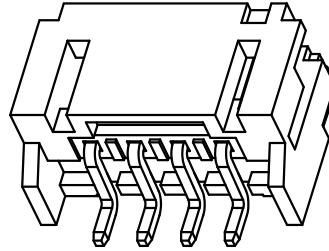
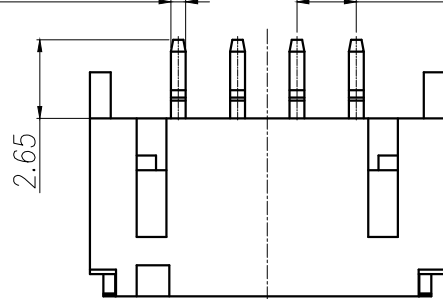


N=0.50 (SQ) 2.00(PITCH)

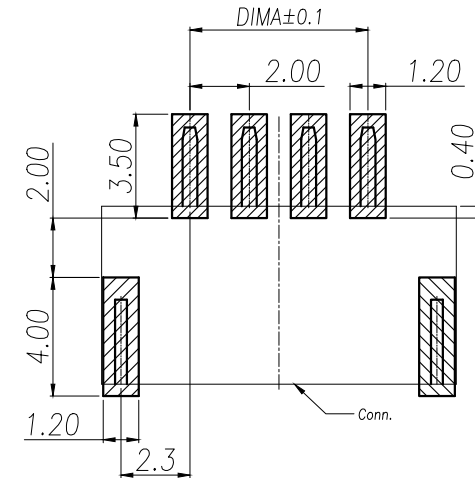


PIN	NO.	Dim A	Dim B	Dim C
2	XY-S02B-PH-SM4	2.00	4.80	7.95
3	XY-S03B-PH-SM4	4.00	6.80	9.95
4	XY-S04B-PH-SM4	6.00	8.80	11.95
5	XY-S05B-PH-SM4	8.00	10.80	13.95
6	XY-S06B-PH-SM4	10.00	12.80	15.95
7	XY-S07B-PH-SM4	12.00	14.80	17.95
8	XY-S08B-PH-SM4	14.00	16.80	19.95
9	XY-S09B-PH-SM4	16.00	18.80	21.95
10	XY-S10B-PH-SM4	18.00	20.80	23.95
11	XY-S11B-PH-SM4	20.00	22.80	25.95
12	XY-S12B-PH-SM4	22.00	24.80	27.95
13	XY-S13B-PH-SM4	24.00	26.80	29.95
14	XY-S14B-PH-SM4	26.00	28.80	31.95
15	XY-S15B-PH-SM4	28.00	30.80	33.95
16	XY-S16B-PH-SM4	30.00	32.80	35.95

NOTES:

- 1.Working temp:-25°C~85°C.
- 2.Voltage rating:100V AV/DC(rms)
- 3.Contact resistance:20mΩ max.
- 4.Insulation resistance:1000MΩ min.
- 5.Current rating:2A AV/DC
- 6.Withstanding Voltage:800V AC/minute
- 7.Pin Retention Force:15N min.
- 8.Housing material:LCP UL94-V0,Natural
- 9.Terminal materl:Brass,
plating Ni 50u" min , plating Tin 100u"min.
- 10.Solder tab material:Brass,
plating Ni 50u" min , plating Tin 100u"min.

PRELIMINARY
DESIGN IS SUBJECT
TO CHANGE WITHOUT
PRIOR NOTICE



RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)

SMT SOLDER AREA

DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyconn Electronics Co.,Ltd			
TOLERANCE UNLESS OTHERWISE SPECIFIED					
.X±0.35	X.*± 5°	APR.	Alex	TITLE: WAFER 2.00mm H5.6mm 90°SMT	
.XX±0.25	.X.*± 3°	CHK.	Jack	DWG NO. XY-SNB-PH-SM4	
.XXX±0.15	.XX.*± 1°	DRA.	Can	PROJ.	CUSTOMER DRAWING
		SIZE A4	SCALE 1:1	SHEET 1/1	REV. A